Study of tetracene thin film transistors using La$_2$O$_3$ as gate insulator

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Tetracene organic field-effect transistors (OFET) have been fabricated and investigated with La$_2$O$_3$ as gate insulator. The fabricated organic thin film transistors exhibit p-type conductivity with field effect mobility $1.04\times10^{-4}$ cm$^2$/V.s, ON-OFF ratio 3.465, sub-threshold swing 17.8 mV/decade and hole concentration $1.25\times10^{19}$ cm$^{-3}$. The SEM and XRD analysis on the semiconductor film were have also been reported.

Keywords: Organic thin film transistors, Tetracene, Gate insulator, Hole concentration, Interface traps

1 Introduction

Organic thin film transistors (OTFT) have gained much interest in recent years due to their flexibility, low cost and easy processing. OTFTs have many electronic applications, such as information display$^1$, chemical sensors$^2,3$, electronic paper$^4$ and microelectronics$^5,6$. The OTFTs can be fabricated by using the simple techniques of vacuum evaporation$^7$ and spin coating. The development of OTFTs is hindered by the poor performance of the device over conventional Ge and Si-TFTs$^8$. In this paper tetracene is used as organic semiconductor and La$_2$O$_3$ as gate insulator. Anderson$^9$ pointed out that the useful guide to a good insulator is to choose one with low optical absorption i.e. one which is colourless and transparent in the film form. La$_2$O$_3$ film is transparent and it has high thermal and chemical stability, high resistivity and low dielectric loss.

2 Experimental Details

The OTFTs were fabricated in staggered electrode structure (Fig. 1). In this structure the metal (Al) source and drain electrodes, with a channel of length 50 µm between them defined by a wire grill, were first deposited on to chemically and ultrasonically cleaned glass slides.

A semiconductor layer of tetracene followed by an insulator (La$_2$O$_3$) was then deposited in steps. Finally a metal (Al) gate electrode was deposite (Fig. 2). The devices were made in a vacuum of better than 8×10$^{-6}$ torr using multiple pump down method. All the materials were properly degassed in vacuum prior to deposition. The various geometrical patterns were defined by metal masks.

3 Results and Discussion

Figure 3 shows the plot of drain current $I_D$ vs drain voltage $V_D$. Here both experimental and theoretical curves are shown. In Fig. 3 the current increases with increasing negative gate voltage. This indicates field-effect-induced hole conduction, which is the expected behaviour for Tetracene. In the linear reason of OTFT the drain current is given by$^{10}$:

$$I_D = \frac{w}{L} \mu C_i \left( V_G - V_T - \frac{V_D}{2} \right) V_D$$

where $w$ is the channel width, $L$ is channel length, $C_i$ is the capacitance per unit area of the gate insulator, $V_T$ is the threshold voltage and $\mu$ is the mobility.
In saturation region $V_D = V_G - V_T$; drain current is given by:

$$I_{D_{sat}} = \frac{W}{2L} \mu C_i (V_G - V_T)^2$$ \hspace{1cm} \ldots (2)$$

Plot of $(I_{D_{sat}})^{1/2}$ versus $V_G$ is shown in the Fig. 4. The field effect mobility $\mu$ is calculated from slope of the linear reason of $(I_{D_{sat}})^{1/2}$ versus $V_G$ graph and the extrapolation of the linear region of the plot to the $V_G$ axis gives the threshold voltage $V_T$. As shown in the Table 1 threshold voltage is $+1.15 \text{V}$. The positive threshold voltage for $p$-channel devices may indicate the presence of unwanted $n$-dopant in the organic layer, thus a positive $V_G$ is needed to switch off the device. The field effect mobility is $1.04 \times 10^{-4} \text{cm}^2/\text{V.s}$. The low value of mobility for this small channel OTFT is due to the fact that the molecules of tetracene cannot completely cover the surface of the gate between source and the drain contacts and there exist the voids at the interface between $\text{La}_2\text{O}_3$ and tetracene thin film. Thus the portion occupied between voids in the gate area becomes larger for small channel length. Therefore in order to improve the interface property one should use the derivatives of tetracene exhibiting an enhanced adhesion to $\text{La}_2\text{O}_3$. Those treatments are under study.

Plot of $\log(I_D)$ versus $V_G$ at a constant drain voltage (15 V) is shown in the Fig. 5. The sub-threshold swing is calculated from the slope of this graph using the relation:

Table — Various parameters used and evaluated

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Channel width ($W$)</td>
<td>0.16 cm</td>
</tr>
<tr>
<td>Channel length ($L$)</td>
<td>0.005 cm</td>
</tr>
<tr>
<td>Capacitance per unit area ($C_i$)</td>
<td>0.009 F/m$^2$</td>
</tr>
<tr>
<td>Channel thickness ($d$)</td>
<td>1300Å</td>
</tr>
<tr>
<td>Threshold voltage ($V_T$)</td>
<td>1.15 V</td>
</tr>
<tr>
<td>Channel Mobility ($\mu$)</td>
<td>$1.04 \times 10^{-4} \text{cm}^2/\text{V.s}$</td>
</tr>
<tr>
<td>Channel Conductivity ($\sigma$)</td>
<td>$2.04 \times 10^{-4} \text{cm}^{-1}$</td>
</tr>
<tr>
<td>Sub threshold swing ($s$)</td>
<td>17.8mV/decade</td>
</tr>
<tr>
<td>$I_{ON}/I_{OFF}$</td>
<td>3.465</td>
</tr>
<tr>
<td>Hole concentration ($N_P$)</td>
<td>$1.25 \times 10^{19} \text{cm}^{-3}$</td>
</tr>
<tr>
<td>Maximum numbers of interface traps present ($N_{SS_{max}}$)</td>
<td>$1.71 \times 10^{12} \text{eV}^{-1} \text{cm}^{-2}$</td>
</tr>
</tbody>
</table>

![Fig. 3 — Variation $I_D$ versus $V_D$ (the dotted lines indicate the practical variations while the smooth lines indicated the theoretical variations)](image)

![Fig. 4 — Plot of $(I_{D_{sat}})^{1/2}$ versus $V_G$](image)

![Fig. 5 — $\log_{10}(I_D)$ versus $V_G$ characteristics for the tetracene TFT at $V_D=15\text{V}$](image)
From the measurement one finds the sub-threshold slope to be 17.8 mV/decade. Normalizing this value to the capacitance of the dielectric gives 16.02 VnF/decade.cm². These values are comparable to what is found for the best pentacene TFTs [14,15] [15-80 VnF/decade.cm²]. Further analysis is possible from the sub-threshold slope calculation. The maximum number of interface traps present is estimated using the following relation assuming that the densities of the deep bulk states and interface states are independent of energy:

\[
N_{ss}^{\text{max}} = \left( \frac{s(\log e) - 1}{KT/q} \right) \frac{C_i}{q}
\]

The channel conductivity \( \sigma \) is estimated from the plot of \( I_D \) versus \( V_D \) graph at zero gate voltage.

The ON-OFF ratio is estimated from the following relation:

\[
\frac{I_{\text{ON}}}{I_{\text{OFF}}} = \frac{c_i \mu (V_G - V_T)^2}{\sigma d V_D}
\]

The surface morphology of the tetracene film is examined with scanning electron microscope (SEM). The tetracene film deposited on the glass substrate is shown in the Fig. 6. This SEM micrograph shows that the tetracene films are polycrystalline in nature and is composed of linear chain of identical crystallites.

In Fig. 7, the XRD pattern of tetracene thin film deposited on glass substrate is shown. The observed Bragg’s peak (001) shows that thin films of tetracene deposited at room temperature is poly crystalline in nature and consist of only thin film phase. It is mainly due to the film deposition at ultrahigh vacuum conditions and at low deposition rate. The peaks indicate that the tetracene molecules are packed parallel to each other in a nearly vertical direction where the c-axis of the tetracene molecule is aligned perpendicular to the substrate.

4 Conclusions

Good quality tetracene thin films under optimum vacuum deposition condition are extracted at room temperature with deposition rate 0.3Å /sec. The devices behave as p-channel transistors working in accumulation mode. The fabricated OTFTs have good performance and well defined I-V characteristics. Various parameters evaluated in this work give good understanding study of the OTFT structure.

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